

Amendments to the Specification:

Please replace the title as follows:

~~RECTIFYING DEVICE AND ELECTRONIC CIRCUIT EMPLOYING SAME, AND~~
~~PROCESS FOR PRODUCING RECTIFYING DEVICE~~
RECTIFYING DEVICE, ELECTRONIC CIRCUIT USING THE SAME, AND METHOD
OF MANUFACTURING RECTIFYING DEVICE

Please replace the paragraph beginning on page 123, line 5, with the following rewritten paragraph:

An aluminum electrode 3 serving as a main electrode was formed in advance on a silicon wafer ~~(not shown)~~ (available from Advantech Co., Ltd, 76.2 mmΦ (diameter of 3 inches), thickness of 380 μm, thickness of a surface oxide film of 1 μm) serving as a substrate. An alumina (Al₂O₃) layer 4 for forming a barrier was laminated by means of deposition on the aluminum electrode 3.